



THE DATASHEET OF ICS513M



LOCO™ PLL CLOCK GENERATOR

ICS513

Description

The ICS513 LOCO™ is the most cost effective way to generate a high quality, high frequency clock output from a 14.31818 MHz crystal or clock input. The name LOCO stands for Low Cost Oscillator, as it is designed to replace crystal oscillators in most electronic systems. Using Phase-Locked-Loop (PLL) techniques, the device uses a standard, inexpensive crystal to produce output clocks up to 100 MHz.

Stored in the chip's ROM is the ability to generate five different output frequencies, allowing one chip to work in different speed processor systems.

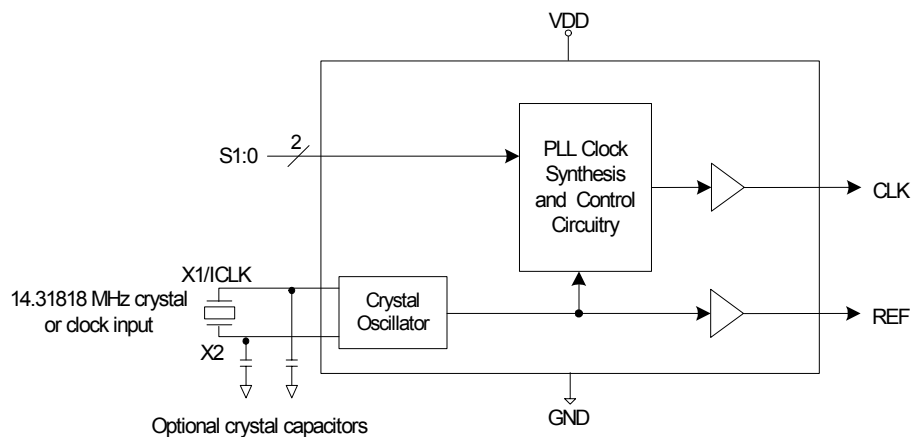
The device also has a power-down mode that turns off the clock outputs when both select pins are low. In this mode, the internal PLL is not running.

Features

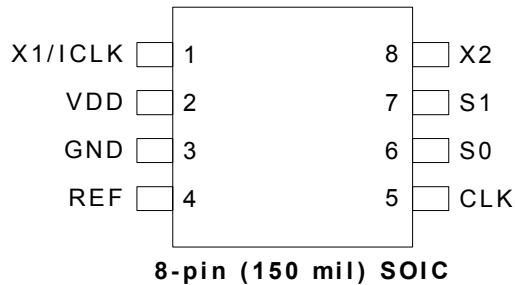
- Packaged as 8-pin SOIC or die
- Available in Pb (lead) free package
- IDT's lowest cost PLL clock plus reference
- Produces common computer frequencies
- Input crystal frequency typically 14.3182 MHz
- Output clock frequencies up to 100 MHz from a 14.3182 MHz crystal or input clock
- Low jitter of 40 ps (one sigma)
- Compatible with all popular CPUs
- Duty cycle of 45/55 up to 200 MHz
- Custom frequencies available
- Operating voltage of 3.3 V to 5.5 V
- Power-down mode turns off chip
- 25 mA drive capability at TTL levels
- Advanced, low-power CMOS process

NOTE: EOL for non-green parts to occur on 5/13/10 per PDN U-09-01

Block Diagram



Pin Assignment



Clock Decoding Table (MHz) with 14.31818 MHz Crystal or Clock Input

S1	S0	CLK	Multiplier	Accuracy
0	0	Power-down CLK	—	—
0	1	100	6.984	1 ppm
M	0	24	1.676	1 ppm
M	1	14.31818	1	0 ppm
1	0	48	3.353	0.017%
1	1	3.6864	0.2576	0.044%

0 = connect directly to ground

1 = connect directly to VDD

M = leave unconnected (floating)

CLK and REF stop low in power-down state

Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	X1/ICLK	Input	Crystal connection to a 14.31818 MHz crystal or clock input.
2	VDD	Power	Connect to +3.3 V or +5 V.
3	GND	Power	Connect to ground.
4	REF	Output	Reference 14.31818 MHz crystal oscillator buffered clock output.
5	CLK	Output	Clock output per table above.
6	S0	Tri-level Input	Select 0 for output clock. Connect to GND or VDD or float. See table above.
7	S1	Tri-level Input	Select 1 for output clock. Connect to GND or VDD or float. See table above.
8	X2	Output	Crystal connection to a 14.31818 MHz crystal. Leave unconnected for clock input.

External Components

Decoupling Capacitor

As with any high-performance mixed-signal IC, the ICS513 must be isolated from system power supply noise to perform optimally.

A decoupling capacitor of 0.01 μ F must be connected between VDD and the GND. It must be connected close to the ICS513 to minimize lead inductance. No external power supply filtering is required for the ICS513.

Series Termination Resistor

A 33 Ω terminating resistor can be used next to the CLK and REF pins for trace lengths over one inch.

Crystal Load Capacitors

The total on-chip capacitance is approximately 12 pF. A parallel resonant, fundamental mode crystal should be used. The device crystal connections should include pads for small capacitors from X1 to ground and from

X2 to ground. These capacitors are used to adjust the stray capacitance of the board to match the nominally required crystal load capacitance. Because load capacitance can only be increased in this trimming process, it is important to keep stray capacitance to a minimum by using very short PCB traces (and no vias) between the crystal and device. Crystal capacitors, if needed, must be connected from each of the pins X1 and X2 to ground.

The value (in pF) of these crystal caps should equal $(C_L - 12 \text{ pF}) * 2$. In this equation, C_L = crystal load capacitance in pF. Example: For a crystal with a 16 pF load capacitance, each crystal capacitor would be 8 pF $[(16 - 12) * 2] = 8$.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS513. These ratings, which are standard values for ICS commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	7 V
All Inputs and Outputs (referenced to GND)	-0.5 V to VDD+0.5 V
Ambient Operating Temperature	0 to +70° C
Storage Temperature	-65 to +150° C
Soldering Temperature	260° C

Recommended Operation Conditions

Parameter	Min.	Typ.	Max.	Units
Ambient Operating Temperature	0		+70	°C
Power Supply Voltage (measured in respect to GND)	+3.0		+5.5	V

DC Electrical Characteristics

VDD=5.0 V ±5% , Ambient temperature 0 to +70° C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		3.0		5.5	V
Input High Voltage, ICLK only	V _{IH}	ICLK (pin 1)	(VDD/2)+1	VDD/2		V
Input Low Voltage, ICLK only	V _{IL}	ICLK (pin 1)		VDD/2	(VDD/2)-1	V
Input High Voltage	V _{IH}	S0	2.0			V
Input Low Voltage	V _{IL}	S0			0.8	V
Input High Voltage	V _{IH}	S1	VDD-0.5			V
Input Mid Voltage	V _{IM}	S1		VDD/2		V
Input Low Voltage	V _{IL}	S1			0.5	V
Output High Voltage	V _{OH}	I _{OH} = -25 mA	2.4			V
Output Low Voltage	V _{OL}	I _{OL} = 25 mA			0.4	V
IDD Operating Supply Current		No load, 100MHz		20		mA
IDD Power-down Supply Current, 3.3 V		S1=S0=0		1.5		mA
Short Circuit Current		CLK output		±70		mA
On-Chip Pull-up Resistor		Pin 6		270		kΩ
Input Capacitance, S1, S0		Pins 6, 7		4		pF

AC Electrical Characteristics

VDD = 5.0 V ±5%, Ambient Temperature 0 to +70° C, unless stated otherwise

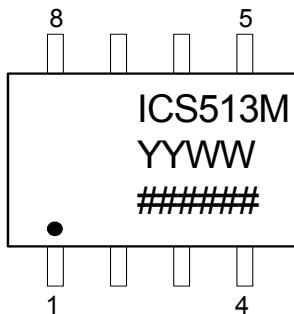
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency, crystal input	F _{IN}		5	14.31818	27	MHz
Input Frequency, clock input	F _{IN}		2	14.31818	50	MHz
Output Frequency, VDD = 4.5 to 5.5 V	F _{OUT}		14	100	140	MHz
Output Frequency, VDD = 3.0 to 3.6 V	F _{OUT}		14	100	100	MHz
Output Clock Rise Time	t _{OR}	0.8 to 2.0 V		1		ns
Output Clock Fall Time	t _{OF}	2.0 to 8.0 V		1		ns
Output Clock Duty Cycle	t _{OD}	1.5 V, up to 140 MHz	45	49-51	55	%

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Power-up time, from PD to outputs stable				5	10	ms
Power-down time, from running to PD state					50	ns
Absolute Clock Period Jitter	t_{ja}	Deviation from mean		± 140		ps
One Sigma Clock Period Jitter	t_{js}			50		ps

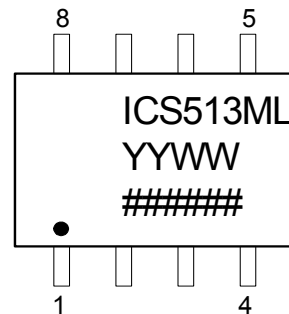
Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Thermal Resistance Junction to Ambient	θ_{JA}	Still air		150		°C/W
	θ_{JA}	1 m/s air flow		140		°C/W
	θ_{JA}	3 m/s air flow		120		°C/W
Thermal Resistance Junction to Case	θ_{JC}			40		°C/W

Marking Diagram



Marking Diagram (Pb free)

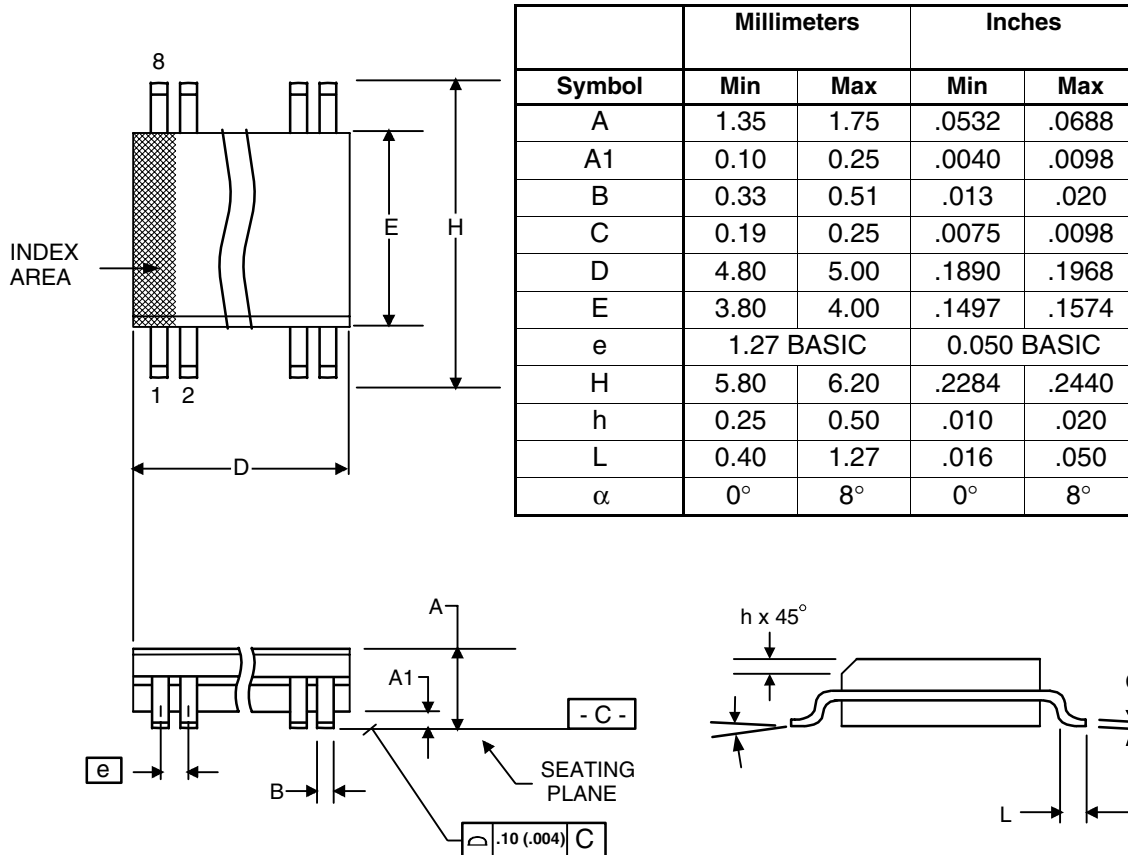


Notes:

- ##### is the lot code.
- YYWW is the last two digits of the year and the week.
- “L” designates Pb (lead) free package.

Package Outline and Package Dimensions (8-pin SOIC, 150 Mil. Narrow Body)

Package dimensions are kept current with JEDEC Publication No. 95



Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
513M*	ICS513M	Tubes	8-pin SOIC	0 to +70° C
513MT*	ICS513M	Tape and Reel	8-pin SOIC	0 to +70° C
513MLF	ICS513ML	Tubes	8-pin SOIC	0 to +70° C
513MLFT	ICS513ML	Tape and Reel	8-pin SOIC	0 to +70° C

***NOTE: EOL for non-green parts to occur on 5/13/10 per PDN U-09-01**

"LF" denotes Pb (lead) free package.

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